

Monolithic Tone Decoder

GENERAL DESCRIPTION

The XR-567 is a monolithic phase-locked loop system designed for general purpose tone and frequency decoding. The circuit operates over a wide frequency band of 0.01 Hz to 500 kHz and contains a logic compatible output which can sink up to 100 milliamps of load current. The bandwidth, center frequency, and output delay are independently determined by the selection of four external components.

The circuit consists of a phase detector, low-pass filter, and current-controlled oscillator which comprise the basic phase-locked loop; plus an additional low-pass filter and quadrature detector that enables the system to distinguish between the presence or absence of an input signal at the center frequency.

FEATURES

- Bandwidth adjustable from 0 to 14%.
- Logic compatible output with 100 mA current sinking capability
- High stable center frequency.
- Center frequency adjustable from 0.01 Hz to 500 kHz
- Inherent immunity to false signals
- High rejection of out-of-band signals and noise
- Frequency range adjustable over 20:1 range by external resistor.

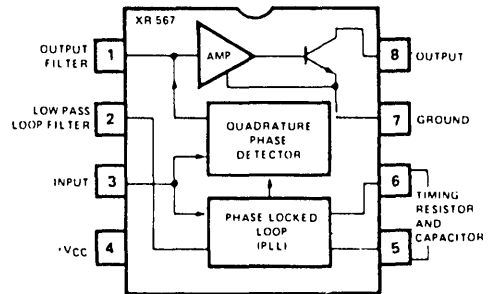
APPLICATIONS

- Touch-Tone® Decoding
- Sequential Tone Decoding
- Communications Paging
- Ultrasonic Remote-Control
- Telemetry Decoding

ABSOLUTE MAXIMUM RATINGS

Power Supply	10 volts
Power Dissipation (package limitation)	
Ceramic Package	385 mW
Plastic Package	300 mW
Derate Above +25°C	2.5 mW/°C
Temperature	
Operating	
XR-567M	-55°C to +125°C
XR-567CN/567CP	0°C to +70°C
Storage	-65°C to +150°C

FUNCTIONAL BLOCK DIAGRAM



ORDERING INFORMATION

Part Number	Package	Operating Temperature
XR-567M	Ceramic	-55°C to +125°C
XR-567CN	Ceramic	0°C to +70°C
XR-567CP	Plastic	0°C to +70°C

SYSTEM DESCRIPTION

The XR-567 monolithic tone decoder consists of a phase detector, low pass filter, and current controlled oscillator which comprise the basic phase-locked loop, plus an additional low pass filter and quadrature detector enabling detection on in-band signals. The device has a normally high open collector output capable of sinking 100 mA.

The input signal is applied to Pin 3 (20 kΩ nominal input resistance). Free running frequency is controlled by an RC network at Pins 5 and 6 and can typically reach 500 kHz. A capacitor on Pin 1 serves as the output filter and eliminates out-of-band triggering. PLL filtering is accomplished with a capacitor on Pin 2; bandwidth and skew are also dependant upon the circuitry here. Bandwidth is adjustable from 0% to 14% of the center frequency. Pin 4 is +V_{CC} (4.75 to 9V nominal, 10V maximum); Pin 7 is ground; and Pin 8 is open collector output, pulling low when an in-band signal triggers the device.

In applications requiring two or more 567-type devices, consider the XR-2567 dual tone decoder. Where center frequency accuracy and drift are critical, compare the XR-567A. Investigate employing the XR-L567 in low power circuits.

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ELECTRICAL CHARACTERISTICS

Test Conditions: $V_{CC} = +5V$, $T_A = 25^\circ C$, unless otherwise specified. Test circuit of Figure 2.

PARAMETERS	LIMITS			UNITS	CONDITIONS
	MIN	TYP	MAX		
GENERAL					
Supply Voltage Range	4.75		9.0	V dc	
Supply Current					
Quiescent XR-567M		6	8	mA	$R_L = 20k\Omega$
XR-567C		7	10	mA	$R_L = 20k\Omega$
Activated XR-567M		11	13	mA	$R_L = 20k\Omega$
XR-567C		12	15	mA	$R_L = 20k\Omega$
Output Voltage			15	V	
Negative Voltage at Input			-10	V	
Positive Voltage at Input			$V_{CC} + 0.5$	V	
CENTER FREQUENCY					
Highest Center Frequency	100	500		kHz	
Center Frequency Stability					
Temperature $T_A = 25^\circ C$		35		ppm/ $^\circ C$	See Figure 9
$0 < T_A < 70^\circ C$		± 60		ppm/ $^\circ C$	See Figure 9
$-55 < T_A < +125^\circ C$		± 140		ppm/ $^\circ C$	See Figure 9
Supply Voltage					
XR-567M		0.5	1.0	%/V	$f_o = 100$ kHz
XR-567C		0.7	2.0	%/V	$f_o = 100$ kHz
DETECTION BANDWIDTH					
Largest Detection Bandwidth					
XR-567M	12	14	16	% of f_o	$f_o = 100$ kHz
XR-567C	10	14	18	% of f_o	$f_o = 100$ kHz
Largest Detection Bandwidth Skew					
XR-567M		1	2	% of f_o	
XR-567C		2	3	% of f_o	
Largest Detection Bandwidth Variation					
Temperature		± 0.1		%/ $^\circ C$	$V_{in} = 300$ mV rms
Supply Voltage		± 2		%/V	$V_{in} = 300$ mV rms
INPUT					
Input Resistance		20		k Ω	
Smallest Detectable Input Voltage		20	25	mV rms	$I_L = 100$ mA, $f_i = f_o$
Largest No-Output Input Voltage	10	15		mV rms	$I_L = 100$ mA, $f_i = f_o$
Greatest Simultaneous Outband					
Signal to Inband Signal Ratio		+6		dB	
Minimum Input Signal to Wideband		-6		dB	$B_n = 140$ kHz
Noise Ratio					
OUTPUT					
Output Saturation Voltage		0.2	0.4	V	$I_L = 30$ mA, $V_{in} = 25$ mV rms
		0.6	1.0	V	$I_L = 100$ mA, $V_{in} = 25$ mV rms
Output Leakage Current		0.01	25	μA	
Fastest ON-OFF Cycling Rate		$f_o/20$			
Output Rise Time		150		ns	$R_L = 50\Omega$
Output Fall Time		30		ns	$R_L = 50\Omega$

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DEFINITION OF XR-567 PARAMETERS

CENTER FREQUENCY f_0

f_0 is the free-running frequency of the current-controlled oscillator with no input signal. It is determined by resistor R_1 between pins 5 and 6, and capacitor C_1 from pin 6 to ground. f_0 can be approximated by

$$f_0 \approx \frac{1}{R_1 C_1}$$

where R_1 is in ohms and C_1 is in farads.

DETECTION BANDWIDTH (BW)

The *detection bandwidth* is the frequency range centered about f_0 , within which an input signal larger than the threshold voltage (typically 20 mV rms) will cause a logic zero state at the output. The detection bandwidth corresponds to the capture range of the PLL and is determined by the low-pass bandwidth filter. The bandwidth of the filter, as a percent of f_0 , can be determined by the approximation

$$BW = 1070 \sqrt{\frac{V_i}{f_0 C_2}}$$

where V_i is the input signal in volts, rms, and C_2 is the capacitance at pin 2 in μF .

LARGEST DETECTION BANDWIDTH

The *largest detection bandwidth* is the largest frequency range within which an input signal above the threshold voltage will cause a logical zero state at the output. The maximum detection bandwidth corresponds to the lock range of the PLL.

DETECTION BAND SKEW

The *detection band skew* is a measure of how accurately the largest detection band is centered about the center frequency, f_0 . It is defined as $(f_{\text{max}} + f_{\text{min}} - 2f_0)/f_0$, where f_{max} and f_{min} are the frequencies corresponding to the edges of the detection band. If necessary, the detection band skew can be reduced to zero by an optional centering adjustment. (See Optional Controls).

DESCRIPTION OF CIRCUIT CONTROLS

OUTPUT FILTER — C_3 (Pin 1)

Capacitor C_3 connected from pin 1 to ground forms a simple low-pass *post detection* filter to eliminate spurious outputs due to out-of-band signals. The time constant of the filter can be expressed as $T_3 = R_3 C_3$, where R_3 (4.7 k Ω) is the internal impedance at pin 1.

The precise value of C_3 is not critical for most applications. To eliminate the possibility of false triggering by spurious signals, it is recommended that C_3 be $\geq 2 C_2$, where C_2 is the loop filter capacitance at pin 2.

If the value of C_3 becomes too large, the *turn-on* or *turn-off* time of the output stage will be delayed until the voltage change across C_3 reaches the threshold voltage. In certain applications, the delay may be desirable as a means of suppressing spurious outputs. Conversely, if the value of C_3 is too small, the beat rate at the output of the quadrature detector (see Functional Block Diagram) may cause a false logic level change at the output. (Pin 8)

The average voltage (during lock) at pin 1 is a function of the inband input amplitude in accordance with the given transfer characteristic.

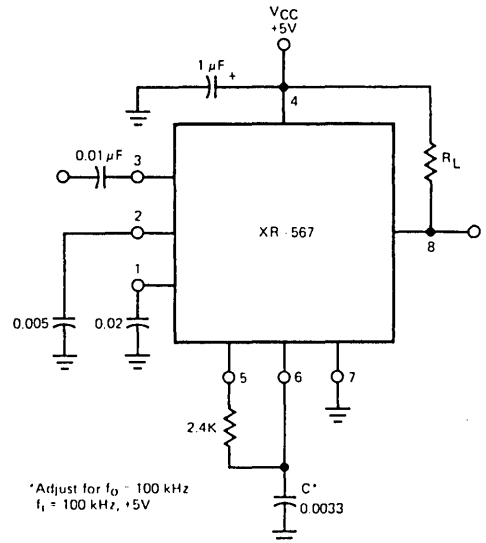


Figure 2. XR-567 Test Circuit

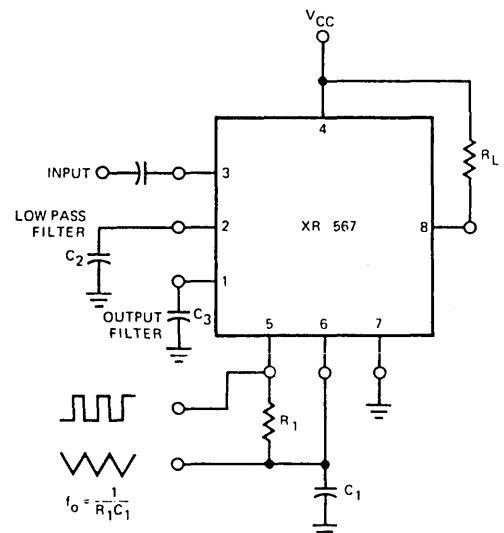


Figure 3. XR-567 Connection Diagram

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TYPICAL CHARACTERISTIC CURVES

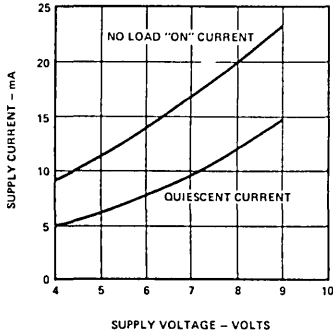


Figure 4. Supply Current Versus Supply Voltage

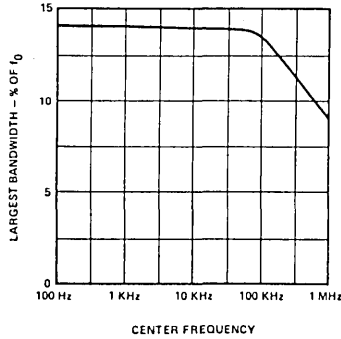


Figure 5. Largest Detection Bandwidth Versus Operating Frequency

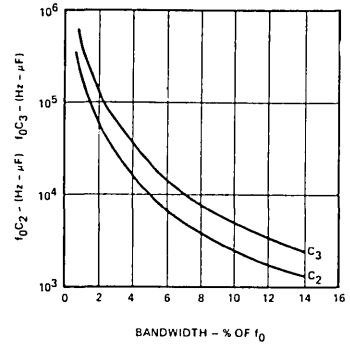


Figure 6. Detection Bandwidth as a Function of C_2 and C_3

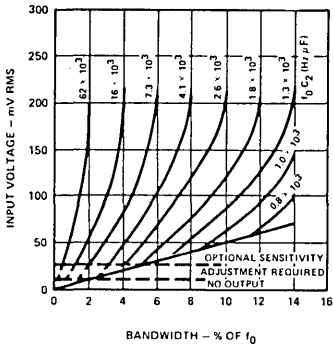


Figure 7. Bandwidth Versus Input Signal Amplitude (C_2 in μF)

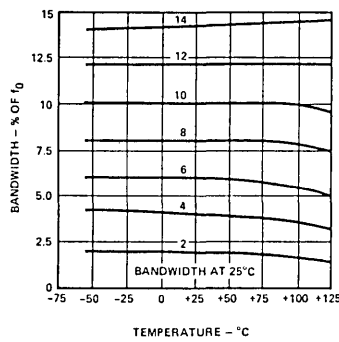


Figure 8. Bandwidth Variation with Temperature

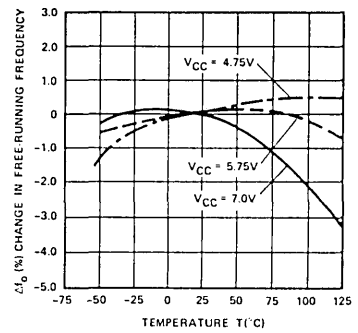


Figure 9. Frequency Drift with Temperature

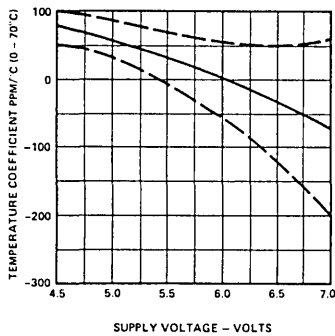


Figure 10. Temperature Coefficient of Center Frequency (Mean and S.D.)

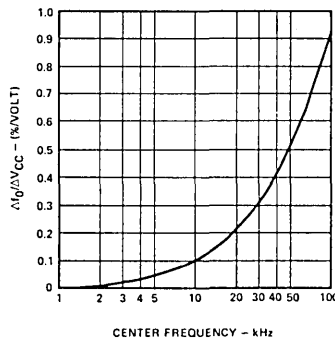


Figure 11. Power Supply Dependence of Center Frequency

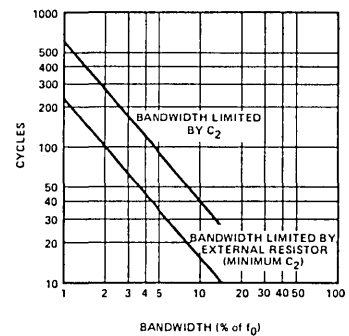


Figure 12. Greatest Number of Cycles Before Output

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LOOP FILTER — C_2 (Pin 2)

Capacitor C_2 connected from pin 2 to ground serves as a single pole, low-pass filter for the PLL portion of the XR-567. The filter time constant is given by $T_2 = R_2C_2$, where R_2 (10 k Ω) is the impedance at pin 2.

The selection of C_2 is determined by the detection bandwidth requirements, as shown in Figure 6. For additional information see section on "Definition of XR-567 Parameters".

The voltage at pin 2, the phase detector output, is a linear function of frequency over the range of 0.95 to 1.05 f_0 , with a slope of approximately 20 mV/% frequency deviation.

INPUT (Pin 3)

The input signal is applied to pin 3 through a coupling capacitor. This terminal is internally biased at a dc level 2 volts above ground, and has an input impedance level of approximately 20 k Ω .

TIMING RESISTOR R_1 AND CAPACITOR C_1 (Pins 5 and 6)

The center frequency of the decoder is set by resistor R_1 between pins 5 and 6, and capacitor C_1 from pin 6 to ground, as shown in Figure 3.

Pin 5 is the oscillator squarewave output which has a magnitude of approximately $V_{CC} - 1.4V$ and an average dc level of $V_{CC}/2$. A 1 k Ω load may be driven from this point. The voltage at pin 6 is an exponential triangle waveform with a peak-to-peak amplitude of 1 volt and an average dc level of $V_{CC}/2$. Only high impedance loads should be connected to pin 6 to avoid disturbing the temperature stability or duty cycle of the oscillator.

LOGIC OUTPUT (Pin 8)

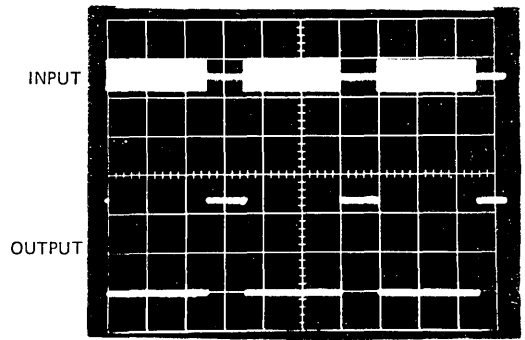
Terminal 8 provides a binary logic output when an input signal is present within the pass-band of the decoder. The logic output is an uncommitted, "base-collector" power transistor capable of switching high current loads. The current level at the output is determined by an external load resistor, R_L , connected from pin 8 to the positive supply.

When an in-band signal is present, the output transistor at pin 8 saturates with a collector voltage less than 1 volt (typically 0.6V) at full rated current of 100 mA. If large output voltage swings are needed, R_L can be connected to a supply voltage, $V+$, higher than the V_{CC} supply. For safe operation, $V+ \leq 20$ volts.

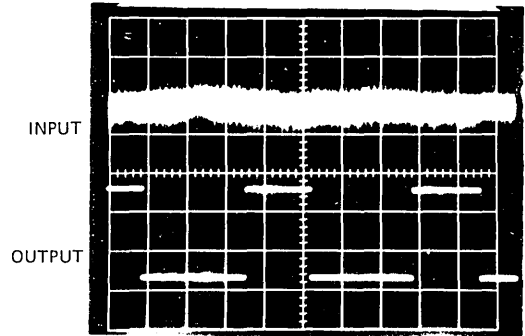
OPERATING INSTRUCTIONS

SELECTION OF EXTERNAL COMPONENTS

A typical connection diagram for the XR-567 is shown in Figure 3. For most applications, the following procedure will be sufficient for determination of the external components R_1 , C_1 , C_2 , and C_3 .



Response to 100 mV rms tone burst.
 $R_L = 100$ ohms.



Response to same input tone burst with wideband noise.

$\frac{S}{N} = -6$ dB $R_L = 100$ ohms

Noise Bandwidth = 140 Hz

Figure 13. Typical Response

- R_1 and C_1 should be selected for the desired center frequency by the expression $f_0 \approx 1/R_1C_1$. For optimum temperature stability, R_1 should be selected such that $2k\Omega \leq R_1 \leq 20$ k Ω , and the R_1C_1 product should have sufficient stability over the projected operating temperature range.
- Low-pass capacitor, C_2 , can be determined from the Bandwidth versus Input Signal Amplitude graph of Figure 7. One approach is to select an area of operation from the graph, and then adjust the input level and value of C_2 accordingly. Or, if the input amplitude variation is known, the required f_0C_2 product can be found to give the desired bandwidth. Constant bandwidth operation requires $V_1 > 200$ mV rms. Then, as noted on the graph, bandwidth will be controlled solely by the f_0C_2 product.
- Capacitor C_3 sets the lead edge of the low-pass filter which attenuates frequencies outside of the detection band and thereby eliminates spurious outputs. If C_3 is too small, frequencies adjacent to the detection band may switch the output stage off and on at the beat frequency, or the output may pulse off and on during the turn-on transient. A typical minimum value of C_3 is 2 C_2 .

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Conversely, if C_3 is too large, turn-on and turn-off of the output stage will be delayed until the voltage across C_3 passes the threshold value.

PRINCIPLE OF OPERATION

The XR-567 is a frequency selective tone decoder system based on the phase-locked loop (PLL) principle. The system is comprised of a phase-locked loop, a quadrature AM detector, a voltage comparator, and an output logic driver. The four sections are internally interconnected as shown in Figure 1.

When an input tone is present within the pass-band of the circuit, the PLL synchronizes or "locks" on the input signal. The quadrature detector serves as a lock indicator: when the PLL is locked on an input signal, the dc voltage at the output of the detector is shifted. This dc level shift is then converted to an output logic pulse by the amplifier and logic driver. The logic driver is a "bare collector" transistor stage capable of switching 100 mA loads.

The logic output at pin 8 is normally in a "high" state, until a tone that is within the capture range of the decoder is present at the input. When the decoder is locked on an input signal, the logic output at pin 8 goes to a "low" state.

The center frequency of the detector is set by the free-running frequency of the current-controlled oscillator in the PLL. This free-running frequency, f_0 , is determined by the selection of R_1 and C_1 connected to pins 5 and 6, as shown in Figure 3. The detection bandwidth is determined by the size of the PLL filter capacitor, C_2 ; and the output response speed is controlled by the output filter capacitor, C_3 .

OPTIONAL CONTROLS

PROGRAMMING

Varying the value of resistor R_1 and/or capacitor C_1 will change the center frequency. The value of R_1 can be changed either mechanically or by solid state switches. Additional C_1 capacitors can be added by grounding them through saturated npn transistors.

SPEED OF RESPONSE

The minimum lock-up time is inversely related to the loop frequency. As the natural loop frequency is lowered, the turn-on transient becomes greater. Thus maximum operating speed is obtained when the value of capacitor C_2 is minimum. At the instant an input signal is applied its phase may drive the oscillator away from the incoming frequency rather than toward it. Under this condition, the lock-up transient is in a worst case situation, and the minimum theoretical lock-up time will not be achievable.

The following expressions yield the values of C_2 and C_3 , in microfarads, which allow the maximum operating speeds for various center frequencies. The minimum rate that digital information may be detected without

losing information due to turn-on transient or output chatter is about 10 cycles/bit, which corresponds to an information transfer rate of $f_0/10$ baud.

$$C_2 = \frac{130}{f_0}, \quad C_3 = \frac{260}{f_0} \mu\text{F}$$

In situations where minimum turn-off time is of less importance than fast turn-on, the optional sensitivity adjustment circuit of Figure 14 can be used to bring the quiescent C_3 voltage closer to the threshold voltage. Sensitivity to beat frequencies, noise, and extraneous signals, however, will be increased.

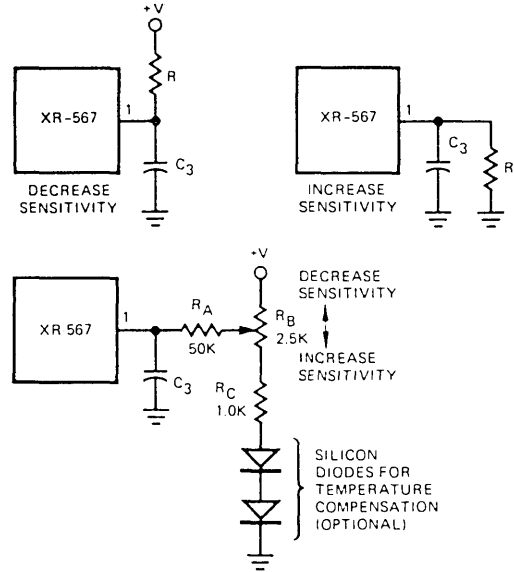


Figure 14. Optional Sensitivity Connections

CHATTER

When the value of C_3 is small, the lock transient and ac components at the lock detector output may cause the output stage to move through its threshold more than once, resulting in output chatter.

Although some loads, such as lamps and relays will not respond to chatter, logic may interpret chatter as a series of output signals. Chatter can be eliminated by feeding a portion of the output back to the input (pin 1) or, by increasing the size of capacitor C_3 . Generally, the feedback method is preferred since keeping C_3 small will enable faster operation. Three alternate schemes for chatter prevention are shown in Figure 15. Generally, it is only necessary to assure that the feedback time constant does not get so large that it prevents operation at the highest anticipated speed.

SKREW ADJUSTMENT

The circuits shown in Figure 16 can be used to change the position of the detection band (capture range) with-

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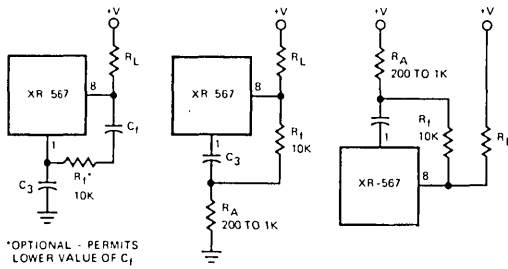


Figure 15. Methods of Reducing Chatter

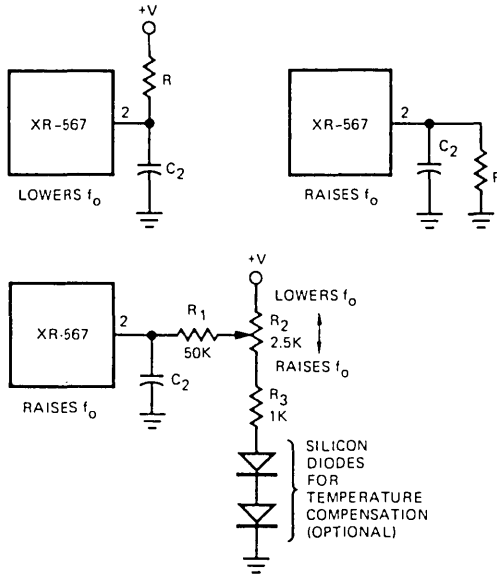


Figure 16. Connections to Reposition Detection Band

in the largest detection band (or lock range). By moving the detection band to either edge of the lock range, input signal variations will expand the detection band in one direction only. Since R_3 also has a slight effect on the duty cycle, this approach may be useful to obtain a precise duty cycle when the circuit is used as an oscillator.

OUTPUT LATCHING

In order to latch the output of the XR-567 "on" after a signal is received, it is necessary to include a feedback resistor around the output stage, between pin 8 and pin 1, as shown in Figure 17. Pin 1 is pulled up to unlatch the output stage.

BANDWIDTH REDUCTION

The bandwidth of the XR-567 can be reduced by either increasing capacitor C_2 or reducing the loop gain. Increasing C_2 may be an undesirable solution since this will also reduce the damping of the loop and thus slow the circuit response time.

Figure 18 shows the proper method of reducing the loop gain for reduced bandwidth. This technique will improve damping and permit faster performance under narrow band operation. The reduced impedance level at pin 2 will require a larger value of C_2 for a given cut-off frequency.

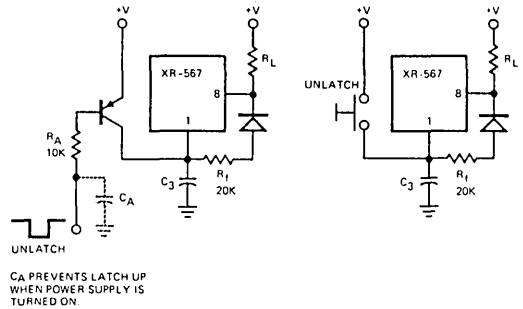
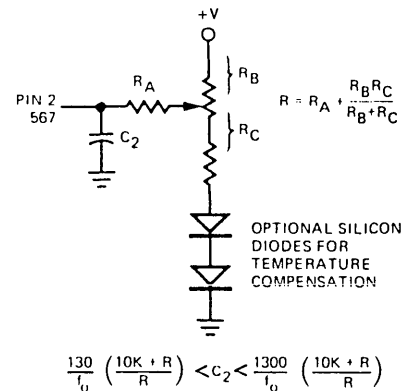
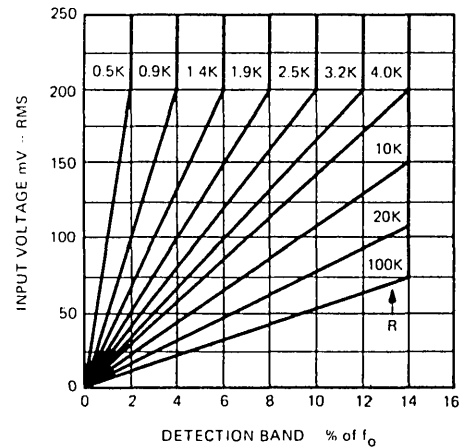


Figure 17. Output Latching



$$\frac{130}{f_0} \left(\frac{10K + R}{R} \right) < C_2 < \frac{1300}{f_0} \left(\frac{10K + R}{R} \right)$$

NOTE: ADJUST CONTROL FOR SYMMETRY OF DETECTION BAND EDGES ABOUT f_0

Figure 18. Bandwidth Reduction

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PRECAUTIONS

1. The XR-567 will lock on signals near $(2n + 1) f_0$ and produce an output for signals near $(4n + 1) f_0$, for $n = 0, 1, 2$ - etc. Signals at $5 f_0$ and $9 f_0$ can cause an unwanted output and should, therefore, be attenuated before reaching the input of the circuit.
2. Operating the XR-567 in a reduced bandwidth mode of operation at input levels less than 200 mV rms results in maximum immunity to noise and out-band signals. Decreased loop damping, however, causes the worst-case lock-up time to increase, as shown by the graph of Figure 12.
3. Bandwidth variations due to changes in the in-band signal amplitude can be eliminated by operating the XR-567 in the high input level mode, above 200 mV. The input stage is then limiting, however, so that out-band signals or high noise levels can cause an apparent bandwidth reduction as the in-band signal is suppressed. In addition, the limited input stage will create in-band components from subharmonic signals so that the circuit components from subharmonic signals so that the circuit becomes sensitive to signals at $f_0/3$, $f_0/5$ etc.
4. Care should be exercised in lead routing and lead lengths should be kept as short as possible. Power supply leads should be properly bypassed close to the integrated circuit and grounding paths should be carefully determined to avoid ground loops and undesirable voltage variations. In addition, circuits requiring heavy load currents should be provided by a separate power supply, or filter capacitors increased to minimize supply voltage variations.

ADDITIONAL APPLICATIONS

DUAL TIME CONSTANT TONE DECODER

For some applications it is important to have a tone decoder with narrow bandwidth and fast response time. This can be accomplished by the dual time constant tone decoder circuit shown in Figure 19. The circuit has two low-pass loop filter capacitors, C_2 and C'_2 . With no input signal present, the output at pin 8 is high, transistor Q_1 is off, and C'_2 is switched out of the circuit. Thus the loop low-pass filter is comprised of C_2 , which can be kept as small as possible for minimum response time.

When an in-band signal is detected, the output at pin 8 will go low, Q_1 will turn on, and capacitor C'_2 will be switched in parallel with capacitor C_2 . The low-pass filter capacitance will then be $C_2 + C'_2$. The value of C'_2 can be quite large in order to achieve narrow bandwidth. Notice that during the time that no input signal is being received, the bandwidth is determined by capacitor C_2 .

NARROW BAND FM DEMODULATOR WITH CARRIER DETECT

For FM demodulation applications where the bandwidth is less than 10% of the carrier frequency, an XR-567

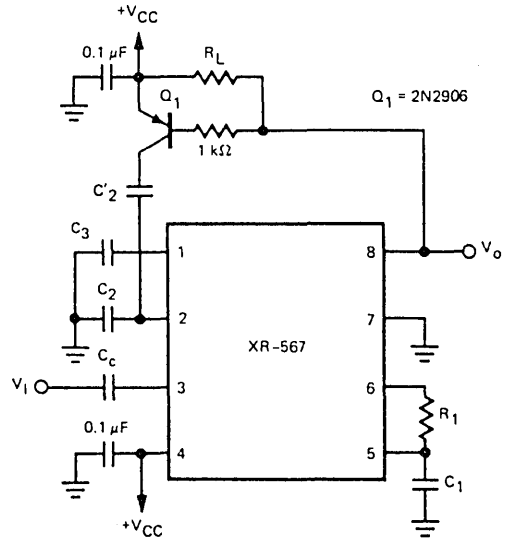


Figure 19. Dual Time Constant Tone Decoder

can be used to detect the presence of the carrier signal. The output of the XR-567 is used to turn off the FM demodulator when no carrier is present, thus acting as a squelch. In the circuit shown, an XR-215 FM demodulator is used because of its wide dynamic range, high signal/noise ratio and low distortion. The XR-567 will detect the presence of a carrier at frequencies up to 500 kHz.

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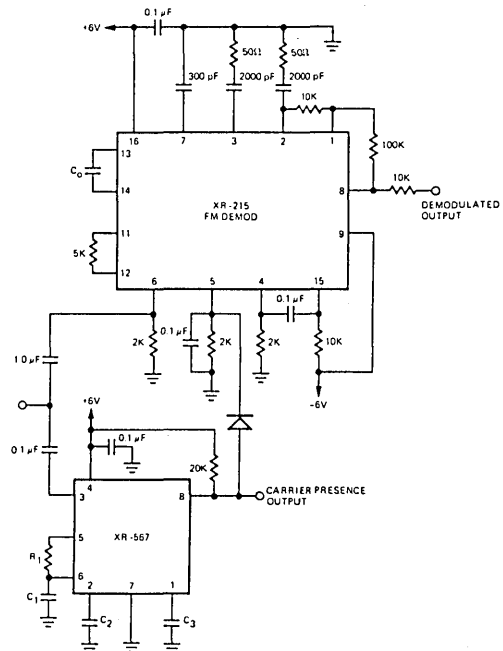


Figure 20. Narrow Band FM Demodulator with Carrier Detect

DUAL TONE DECODER

In dual tone communication systems, information is transmitted by the simultaneous presence of two separate tones at the input. In such applications two XR-567 units can be connected in parallel, as shown in Figure 21 to form a dual tone decoder. The resistor and capacitor values of each decoder are selected to provide the desired center frequencies and bandwidth requirements.

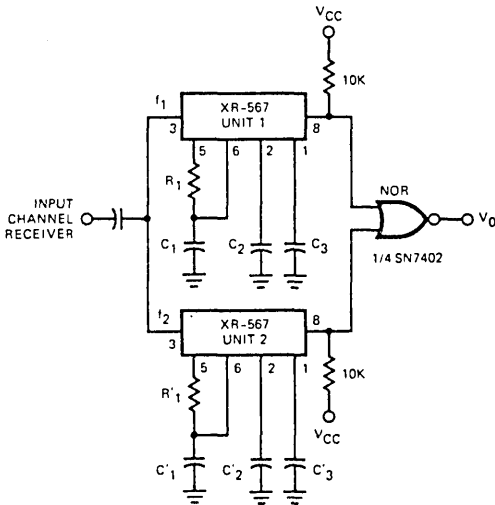


Figure 21. Dual Tone Decoder

PRECISION OSCILLATOR

The current-controlled oscillator (CCO) section of the XR-567 provides two basic output waveforms as shown in Figure 22. The squarewave is obtained from pin 5, and the exponential ramp from pin 6. The relative phase relationships of the waveforms are also provided in the figure. In addition to being used as a general purpose oscillator or clock generator, the CCO can also be used for any of the following special purpose oscillator applications:

1. High-Current Oscillator

The oscillator output of the XR-567 can be amplified using the output amplifier and high-current logic output available at pin 8. In this manner, the circuit can switch 100 mA load currents without sacrificing oscillator stability. A recommended circuit connection for this application is shown in Figure 23. The oscillator frequency can be modulated over $\pm 6\%$ in frequency by applying a control voltage to pin 2.

2. Oscillator with Quadrature Outputs

Using the circuit connection of Figure 24 the XR-567 can function as a precision oscillator with two separate squarewave outputs (at pins 5 and 8, respectively) that are at nearly quadrature phase with each

other. Due to the internal biasing arrangement the actual phase shift between the two outputs is typically 80° .

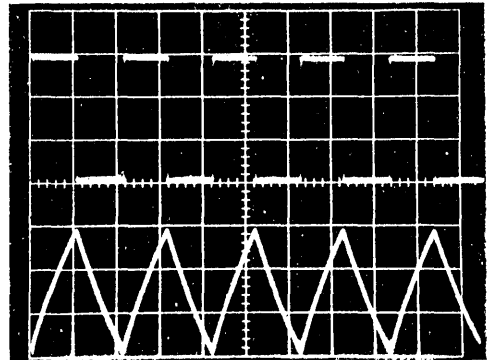


Figure 22. Oscillator Output Waveform Available From CCO Section.

Top: Square Wave Output at Pin 5:

Amplitude = $(V^+ - 1.4V)$, pp.,

Avg. Value = $V^+ / 2$

Bottom: Exponential Triangle Wave at Pin 6:

Amplitude = $1V$ pp., Avg. Value = $V^+ / 2$

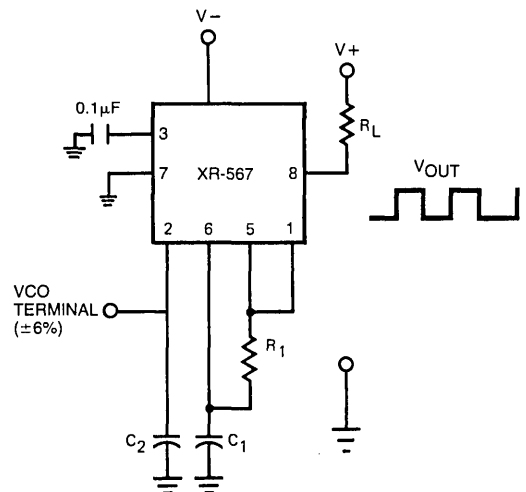


Figure 23. Precision Oscillator to Switch 100 mA Loads

3. Oscillator with Frequency Doubled Output

The CCO frequency can be doubled by applying a portion of the squarewave output at pin 5 back to the input at pin 3, as shown in Figure 25. In this manner, the quadrature detector functions as a frequency doubler and produces an output of $2f_0$ at pin 8.

FSK DECODING

XR-567 can be used as a low speed FSK demodulator. In this application the center frequency is set to one of

XR-567

the input frequencies, and the bandwidth is adjusted to leave the second frequency outside the detection band. When the input signal is frequency keyed between the *in-band* signal and the *out-band* signal, the logic state of the output at pin 8 is reversed. Figure 26 shows the FSK input ($f_2 = 3 f_1$) and the demodulated output signals, with $f_0 = f_2 = 1$ kHz. The circuit can handle data rates up to $f_0/10$ baud.

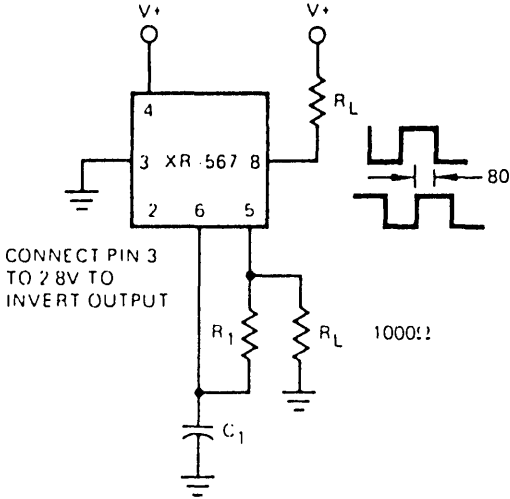


Figure 24. Oscillator with Quadrature Output

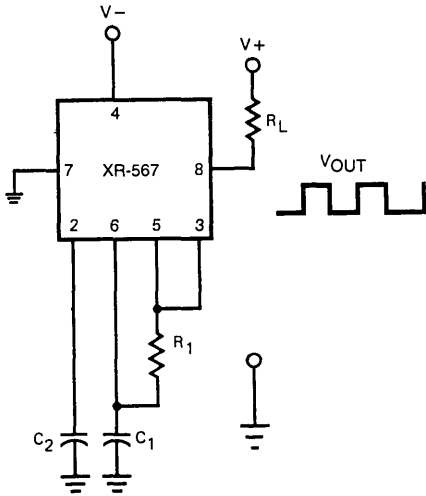


Figure 25. Oscillator with Double Frequency Output

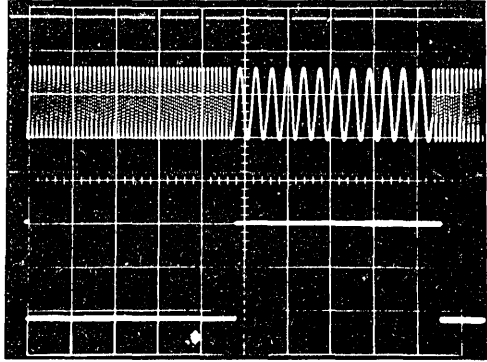
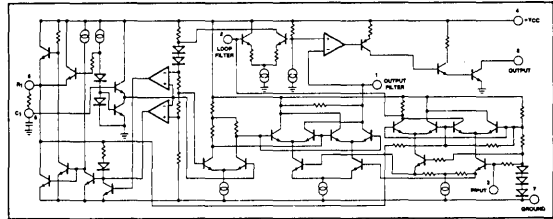


Figure 26. Input and Output Waveforms for FSK Decoding
Top: Input FSK Signal ($f_2 = 3f_1$)
Bottom: Demodulated Output



EQUIVALENT SCHEMATIC DIAGRAM